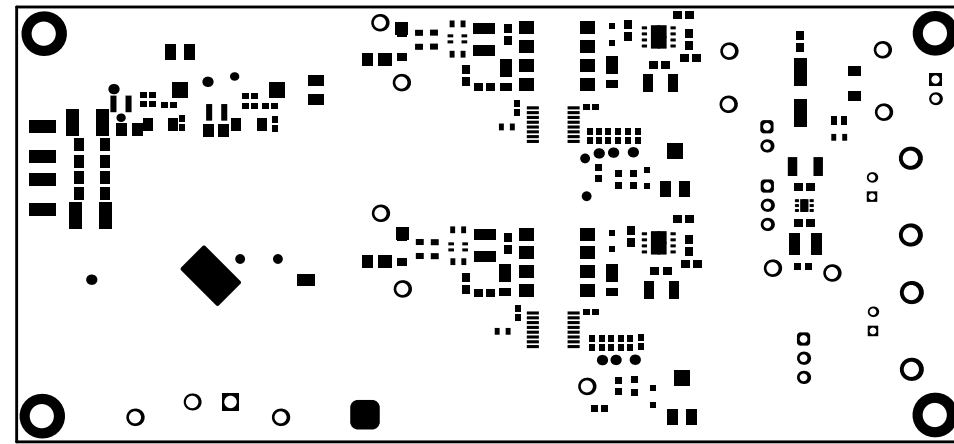
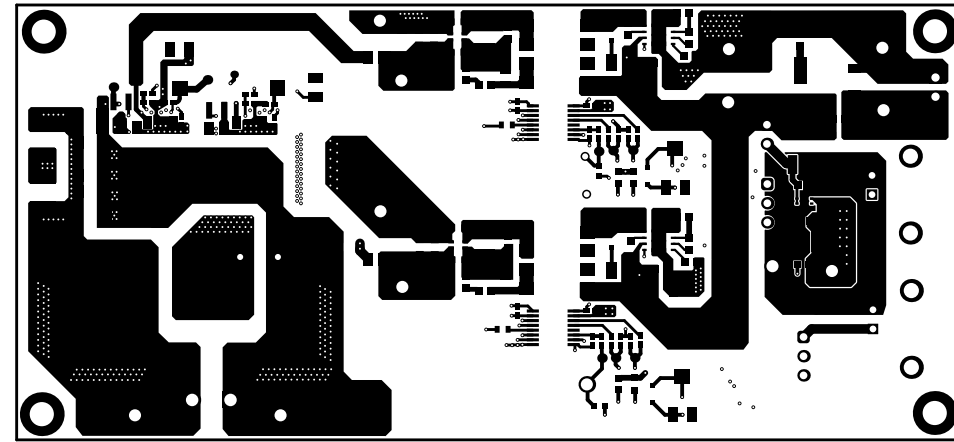


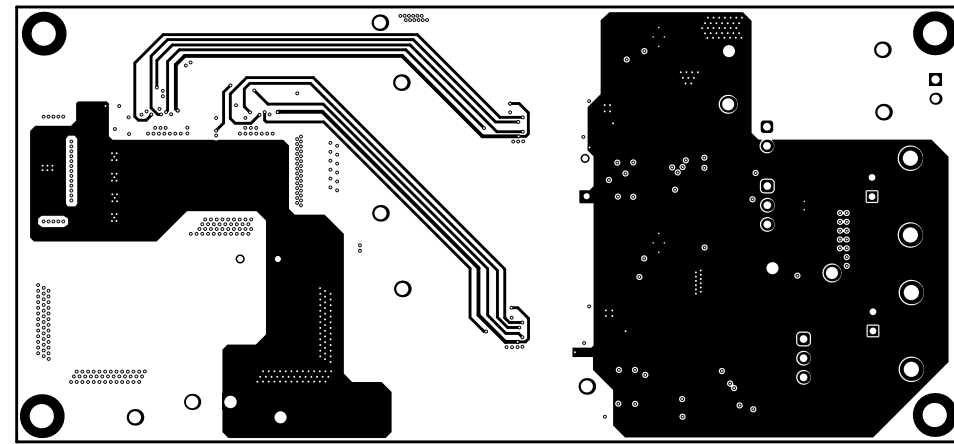
	BOARD #:	PMP31182	REV:	.PCB_Rev	SUN REV:	Not in version control
Top Overlay	GENERATED :	1/15/2024	6:26:37 PM	TEXAS INSTRUMENTS		



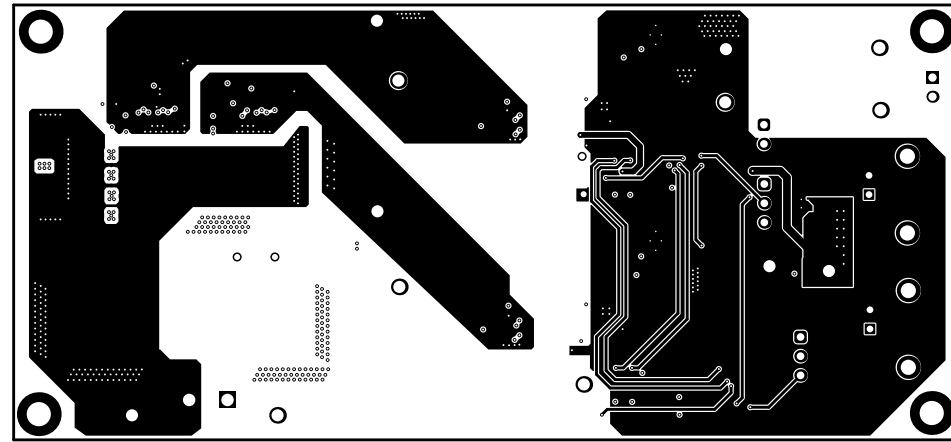
	BOARD #:	PHP3E182	REV:	.PCB_Rev	SUN REV:	Not in version control
Top Solder Mask	GENERATED :	1/15/2024	6:26:38 PM	TEXAS INSTRUMENTS		



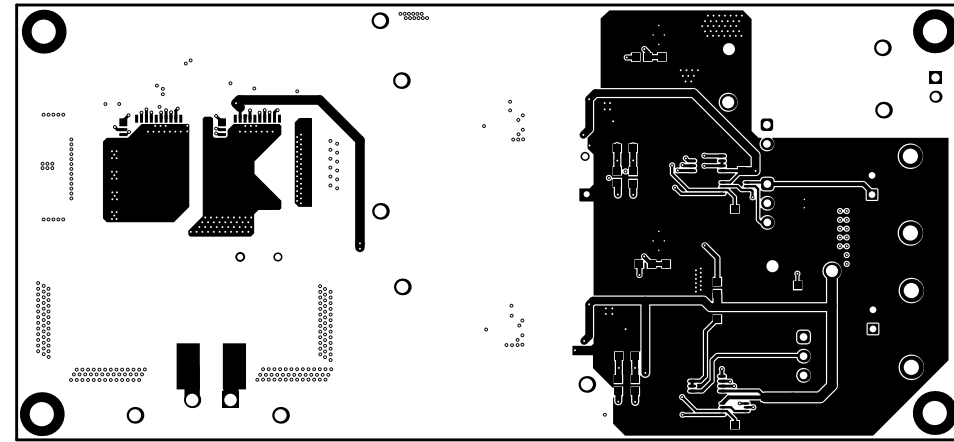
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Top Layer	GENERATED :	1/15/2024	6:26:38 PM	TEXAS INSTRUMENTS		



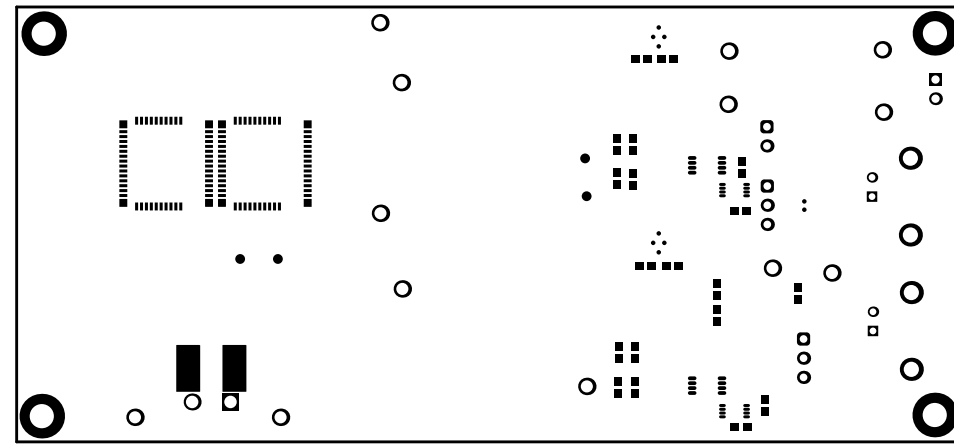
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Signal Layer 1	GENERATED :	1/15/2024	6:26:38 PM	TEXAS INSTRUMENTS		



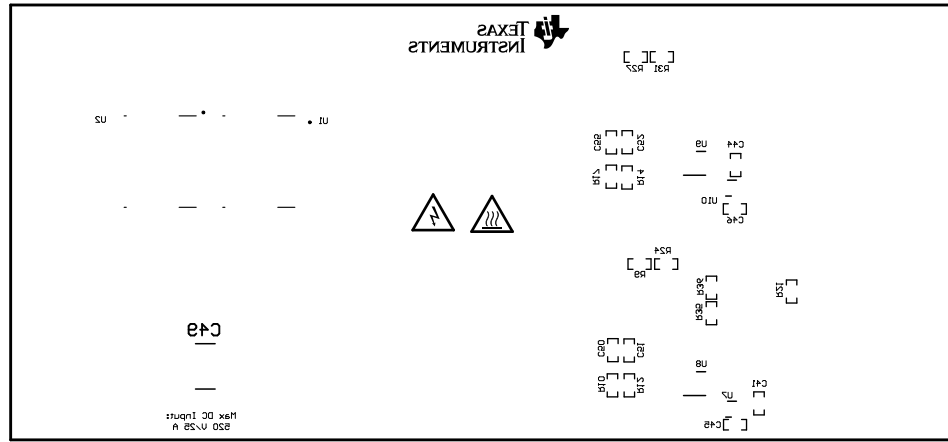
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Signal Layer 2	GENERATED :	1/15/2024	6:26:38 PM	TEXAS INSTRUMENTS		



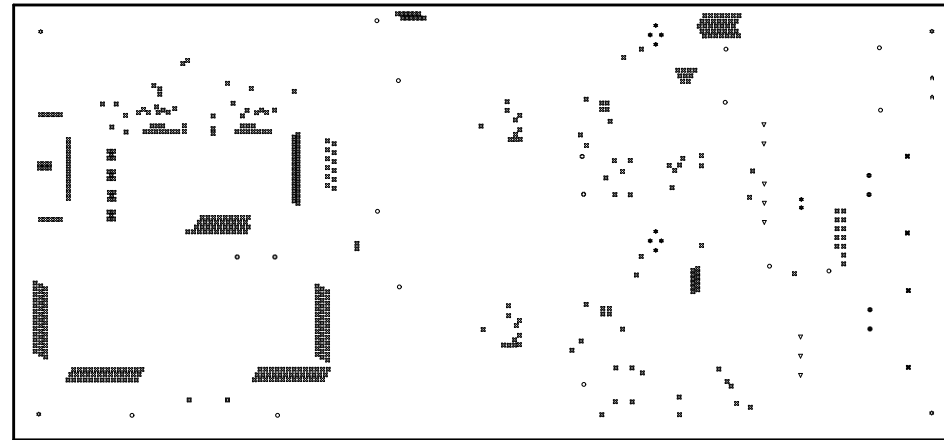
	BOARD #:	PHP3E182	REV:	._PCB_Rev	SUN REV:	Not in version control
Bottom Layer	GENERATED :	1/15/2024	6:26:39 PM	TEXAS INSTRUMENTS		



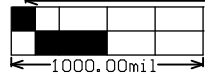
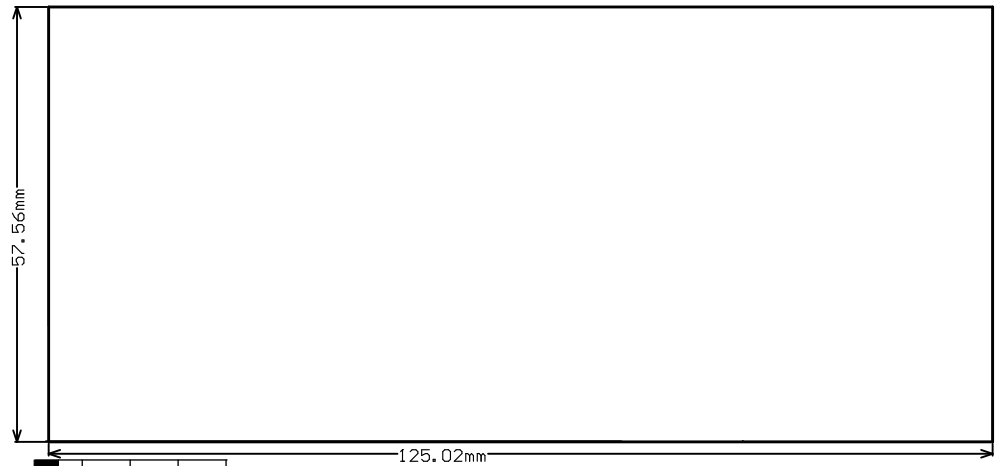
	BOARD #:	PHP3E182	REV:	.PCB_Rev	SUN REV:	Not in version control
Bottom Solder Mask	GENERATED :	1/15/2024	6:26:39 PM	TEXAS INSTRUMENTS		



	BOARD #:	PHP3E182	REV:	.PCB_Rev	SUN REV:	Not in version control
Bottom Overlay	GENERATED :	1/15/2024	6:26:39 PM	TEXAS INSTRUMENTS		



	BOARD #:	PHP3E182	REV:	.PCB_Rev	SUN REV:	Not in version control
Drill Drawing	GENERATED :	1/15/2024	6:26:39 PM	TEXAS INSTRUMENTS		



	BOARD #:	PHP3E182	REV:	.PCB_Rev	SUN REV:	Not in version control
M2 Board Dimensions						
Board Dimensions	GENERATED :	1/15/2024	6:26:40 PM	TEXAS INSTRUMENTS		

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